

SPECIFICATION FOR RoHS 6 COMPLIANT HCMOS SMT OSCILLATOR MtronPTI P/N: M2002T158

Electrical Specifications:

Parameter	Symbol	Min.	Typ.	Max.	Units	Conditions
Frequency of Operation	F _O		24.000000		MHz	
Frequency Stability	ΔF/F	-100		+100	ppm	
Operating Temperature	T _A	-40		+85	°C	
Storage Temperature	T _S	-55		+125	°C	
Aging		-3		+3	ppm	1 st year
		-2		+2	ppm	Thereafter (per year)
Operating Voltage	V _{DD}	3.0	3.3	3.6	V	
Operating Current	I _{DD}			20	mA	
Output Type		HCMOS Compatible				
Output Load		15			pF	
Symmetry (duty cycle)	T _{DC}	45		55	%	Ref to ½ V _{DD}
Logic "1" Level	V _{OH}	90% V _{DD}			V	HCMOS load
Logic "0" Level	V _{OL}			10% V _{DD}	V	HCMOS load
Rise/Fall Time	T _R /T _F			6	nS	From 10% to 90% V _{DD}
Tri-state Enable Logic		80% V _{DD} or N/C			V	Pad 1. Clock Signal Output
Tri-state Disable Logic				20% V _{DD}	V	Pad 1. Output to high-Z
Start-up Time	T _{SU}			10	mS	

Environmental Conditions:

Mechanical Shock	Per JESD22-B-104-A 1500g Peak 0.5 msec duration 5 pulses in 6 directions
Vibration	Per JESD22-B-103-A 20g Peak (20-2000 Hz) in X, Y and Z directions
Thermal Cycle	Per MIL-STD-883, Method 1010, B (-55°C to 125°C, 15 min. dwell, 10 cycles)
Hermeticity	Per MIL-STD-202, Method 112 (1 x 10 ⁻⁸ atm cc/s of Helium)
ESD-Human Body Model	2000 volts; Per JESD22A-114-A
ESD-Machine Model	200 volts; Per JESD22A-115-A
Solderability	Per EIAJ-STD-002
Max. Soldering Conditions	See solder profile, Figure 1
Package Type	5.0 x 7.0 x 1.7 mm, 4-pad Ceramic Leadless Chip Carrier (M2 type)
Termination (Pad) Material	10 to 15 μm of tungsten (W), 1.29 to 8.89 μm of nickel (Ni), 0.3 to 1.0 μm of gold (Au)
Moisture Sensitivity Level	1

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Mechanical, Marking and Layout Information:

Pad	Function
1	Tri-state
2	Ground
3	Output
4	+V _{DD}

Part Marking	
Line 1	M2002T158
Line 2	24M0000
Line 3	M yy ww vv

Legend	
yy	Year
ww	Work week
vv	Factory code

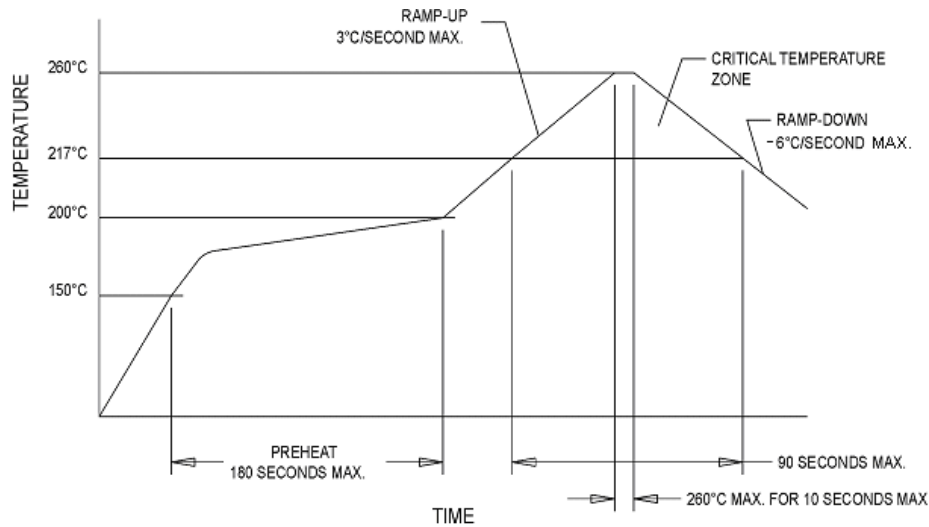
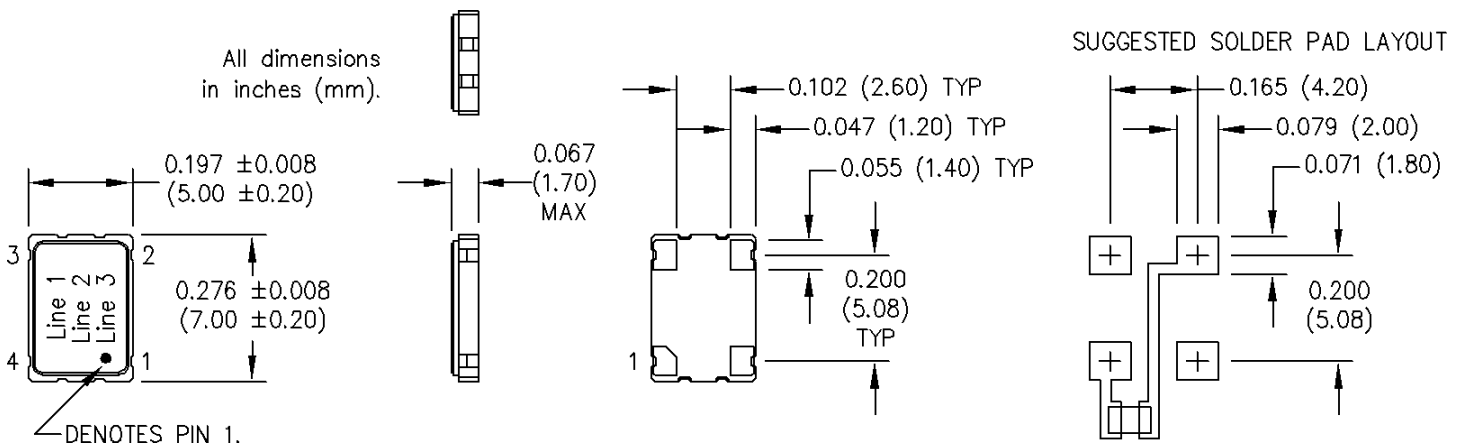


Figure 1

Datasheet Revision Table:

Date	Rev.	Author	Details of Revision
2/6/13	0	MM	Original release.